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Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	83
Number of Gates	14000
Voltage - Supply	3V ~ 3.6V, 4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	100-TQFP
Supplier Device Package	100-VQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/a42mx09-vq100

2.6 Temperature Grade Offerings

Table 4 • Temperature Grade Offerings

Package	A40MX02	A40MX04	A42MX09	A42MX16	A42MX24	A42MX36
PLCC 44	C, I, M	C, I, M				
PLCC 68	C, I, A, M	C, I, M				
PLCC 84		C, I, A, M	C, I, A, M	C, I, M	C, I, M	
PQFP 100	C, I, A, M	C, I, A, M	C, I, A, M	C, I, M		
PQFP 144			C			
PQFP 160			C, I, A, M	C, I, M	C, I, A, M	
PQFP 208				C, I, A, M	C, I, A, M	C, I, A, M
PQFP 240						C, I, A, M
VQFP 80	C, I, A, M	C, I, A, M				
VQFP 100			C, I, A, M	C, I, A, M		
TQFP 176			C, I, A, M	C, I, A, M	C, I, A, M	
PBGA 272						C, I, M
CQFP 172				C, M, B		
CQFP 208						C, M, B
CQFP 256						C, M, B
CPGA 132			C, M, B			

Note: C = Commercial
I = Industrial
A = Automotive
M = Military
B = MIL-STD-883 Class B

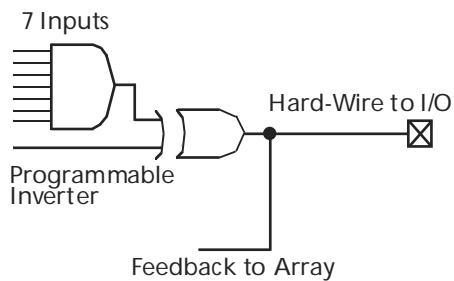
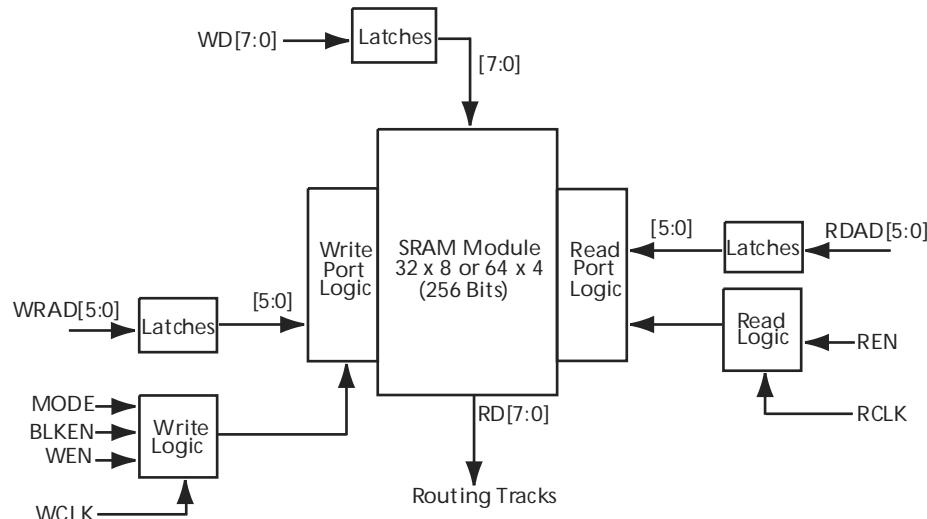
2.7 Speed Grade Offerings

Table 5 • Speed Grade Offerings

	-F	Std	-1	-2	-3
C	P	P	P	P	P
I		P	P	P	P
A		P			
M		P	P		
B		P	P		

Note: See the 40MX and 42MX Automotive Family FPGAs datasheet for details on automotive-grade MX offerings.

Contact your local *Microsemi Sales representative* for device availability.

Figure 5 • A42MX24 and A42MX36 D-Module Implementation**Figure 6 • A42MX36 Dual-Port SRAM Block**

3.2.3 Routing Structure

The MX architecture uses vertical and horizontal routing tracks to interconnect the various logic and I/O modules. These routing tracks are metal interconnects that may be continuous or split into segments. Varying segment lengths allow the interconnect of over 90% of design tracks to occur with only two antifuse connections. Segments can be joined together at the ends using antifuses to increase their lengths up to the full length of the track. All interconnects can be accomplished with a maximum of four antifuses.

3.2.3.1 Horizontal Routing

Horizontal routing tracks span the whole row length or are divided into multiple segments and are located in between the rows of modules. Any segment that spans more than one-third of the row length is considered a long horizontal segment. A typical channel is shown in Figure 7, page 10. Within horizontal routing, dedicated routing tracks are used for global clock networks and for power and ground tie-off tracks. Non-dedicated tracks are used for signal nets.

3.2.3.2 Vertical Routing

Another set of routing tracks run vertically through the module. There are three types of vertical tracks: input, output, and long. Long tracks span the column length of the module, and can be divided into multiple segments. Each segment in an input track is dedicated to the input of a particular module; each segment in an output track is dedicated to the output of a particular module. Long segments are uncommitted and can be assigned during routing.

Each output segment spans four channels (two above and two below), except near the top and bottom of the array, where edge effects occur. Long vertical tracks contain either one or two segments. An example of vertical routing tracks and segments is shown in Figure 7, page 10.

Note: *Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the recommended operating conditions.

Table 14 • Recommended Operating Conditions

Parameter	Commercial	Industrial	Military	Units
Temperature Range*	0 to +70	–40 to +85	–55 to +125	°C
VCC (40MX)	4.75 to 5.25	4.5 to 5.5	4.5 to 5.5	V
VCCA (42MX)	4.75 to 5.25	4.5 to 5.5	4.5 to 5.5	V
VCCI (42MX)	4.75 to 5.25	4.5 to 5.5	4.5 to 5.5	V

Note: * Ambient temperature (T_A) is used for commercial and industrial grades; case temperature (T_C) is used for military grades.

3.7.1 5 V TTL Electrical Specifications

The following tables show 5 V TTL electrical specifications.

Table 15 • 5V TTL Electrical Specifications

Symbol	Parameter	Commercial		Commercial -F		Industrial		Military		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
VOH ¹	IOH = –10 mA	2.4		2.4						V
	IOH = –4 mA					3.7		3.7		V
VOL ¹	IOL = 10 mA	0.5		0.5						V
	IOL = 6 mA					0.4		0.4		V
VIL		–0.3	0.8	–0.3	0.8	–0.3	0.8	–0.3	0.8	V
VIH (40MX)		2.0	VCC + 0.3	2.0	VCC + 0.3	2.0	VCC + 0.3	2.0	VCC + 0.3	V
VIH (42MX) ²		2.0	VCCI + 0.3	2.0	VCCI + 0.3	2.0	VCCI + 0.3	2.0	VCCI + 0.3	V
IIL	VIN = 0.5 V	–10		–10		–10		–10		μA
IIH	VIN = 2.7 V	–10		–10		–10		–10		μA
Input Transition Time, T_R and T_F		500		500		500		500		ns
C_{IO} I/O Capacitance		10		10		10		10		pF
Standby Current, ICC^3	A40MX02, A40MX04	3		25		10		25		mA
	A42MX09	5		25		25		25		mA
	A42MX16	6		25		25		25		mA
	A42MX24, A42MX36	20		25		25		25		mA
Low power mode Standby Current	42MX devices only	0.5		ICC – 5.0		ICC – 5.0		ICC – 5.0		mA
IIO, I/O source sink current	Can be derived from the <i>IBIS model</i> (http://www.microsemi.com/soc/techdocs/models/ibis.html)									

1. Only one output tested at a time. VCC/VCCI = min

2. VIH(Min) is 2.4V for A42MX36 family. This applies only to VCCI of 5V and is not applicable to VCCI of 3.3V

3.9.1 Mixed 5.0V/3.3V Electrical Specifications

Table 22 • Mixed 5.0V/3.3V Electrical Specifications

Symbol	Parameter	Commercial		Commercial –F		Industrial		Military		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
VOH ¹	IOH = -10 mA	2.4		2.4				2.4		V
	IOH = -4 mA					2.4		2.4		V
VOL ¹	IOL = 10 mA	0.5		0.5				0.4		V
	IOL = 6 mA					0.4		0.4		V
VIL		-0.3	0.8	-0.3	0.8	-0.3	0.8	-0.3	0.8	V
VIH ²		2.0	VCCA + 0.3	2.0	VCCA + 0.3	2.0	VCCA + 0.3	2.0	VCCA + 0.3	V
IL	VIN = 0.5 V	-10		-10		-10		-10		µA
IH	VIN = 2.7 V	-10		-10		-10		-10		µA
Input Transition Time, T _R and T _F		500		500		500		500		ns
C _{IO}	I/O Capacitance	10		10		10		10		pF
Standby Current, ICC ³	A42MX09	5		25		25		25		mA
	A42MX16	6		25		25		25		mA
	A42MX24, A42MX36	20		25		25		25		mA
Low Power Mode Standby Current		0.5		ICC – 5.0		ICC – 5.0		ICC – 5.0		mA
IIO I/O source sink	Can be derived from the <i>IBIS model</i> (http://www.microsemi.com/soc/techdocs/models/ibis.html) current									

1. Only one output tested at a time. VCCI = min.

2. VIH(Min) is 2.4V for A42MX36 family. This applies only to VCCI of 5V and is not applicable to VCCI of 3.3V

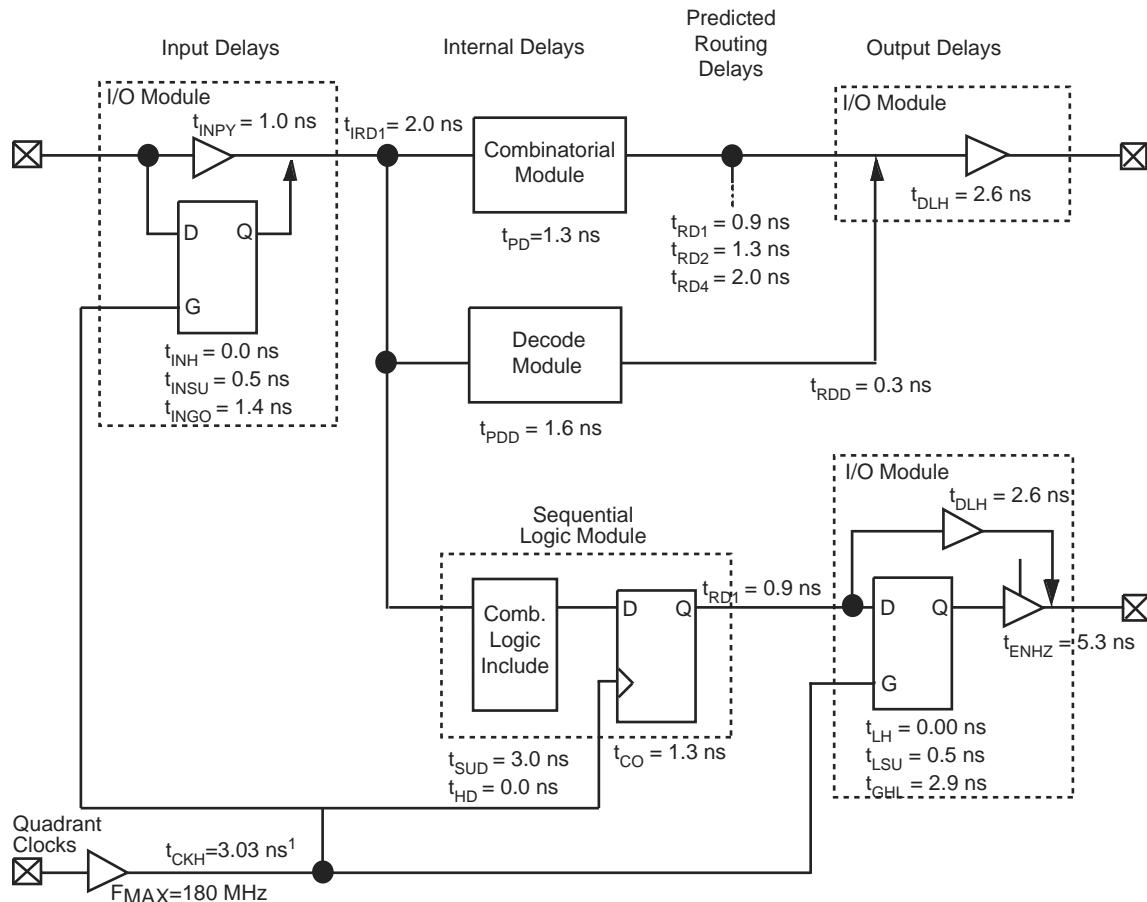
3. All outputs unloaded. All inputs = VCCI or GND

3.9.2 Output Drive Characteristics for 5.0 V PCI Signaling

MX PCI device I/O drivers were designed specifically for high-performance PCI systems. Figure 16, page 28 shows the typical output drive characteristics of the MX devices. MX output drivers are compliant with the PCI Local Bus Specification.

Table 23 • DC Specification (5.0 V PCI Signaling)¹

Symbol	Parameter	PCI		MX		Units	
		Condition	Min.	Max.	Min.		
VCCI	Supply Voltage for I/Os		4.75	5.25	4.75	5.25 ²	V
VIH ³	Input High Voltage		2.0	VCC + 0.5	2.0	VCCI + 0.3	V
VIL	Input Low Voltage		-0.5	0.8	-0.3	0.8	V
IIH	Input High Leakage Current	VIN = 2.7 V		70	—	10	µA
IIL	Input Low Leakage Current	VIN=0.5 V		-70	—	-10	µA
VOH	Output High Voltage	IOUT = -2 mA IOUT = -6 mA	2.4		3.84		V
VOL	Output Low Voltage	IOUT = 3 mA, 6 mA	0.55		—	0.33	V

Figure 19 • 42MX Timing Model (Logic Functions Using Quadrant Clocks)

Note: 1. Load-dependent

Note: 2. Values are shown for A42MX36 –3 at 5.0 V worst-case commercial conditions

Table 38 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, TJ = 70°C)

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Input Module Propagation Delays											
t _{INYH}	Pad-to-Y HIGH		1.0	1.2	1.3	1.6	2.2	ns			
t _{INYL}	Pad-to-Y LOW		0.8	0.9	1.0	1.2	1.7	ns			
t _{INGH}	G to Y HIGH		1.3	1.4	1.6	1.9	2.7	ns			
t _{INGL}	G to Y LOW		1.3	1.4	1.6	1.9	2.7	ns			
Input Module Predicted Routing Delays²											
t _{IRD1}	FO = 1 Routing Delay		2.0	2.2	2.5	3.0	4.2	ns			
t _{IRD2}	FO = 2 Routing Delay		2.3	2.5	2.9	3.4	4.7	ns			
t _{IRD3}	FO = 3 Routing Delay		2.5	2.8	3.2	3.7	5.2	ns			
t _{IRD4}	FO = 4 Routing Delay		2.8	3.1	3.5	4.1	5.7	ns			
t _{IRD8}	FO = 8 Routing Delay		3.7	4.1	4.7	5.5	7.7	ns			
Global Clock Network											
t _{CKH}	Input LOW to HIGH	FO = 32	2.4	2.7	3.0	3.6	5.0	ns			
		FO = 256	2.7	3.0	3.4	4.0	5.5	ns			
t _{CKL}	Input HIGH to LOW	FO = 32	3.5	3.9	4.4	5.2	7.3	ns			
		FO = 256	3.9	4.3	4.9	5.7	8.0	ns			
t _{PWH}	Minimum Pulse Width HIGH	FO = 32	1.2	1.4	1.5	1.8	2.5	ns			
		FO = 256	1.3	1.5	1.7	2.0	2.7	ns			
t _{PWL}	Minimum Pulse Width LOW	FO = 32	1.2	1.4	1.5	1.8	2.5	ns			
		FO = 256	1.3	1.5	1.7	2.0	2.7	ns			
t _{CKSW}	Maximum Skew	FO = 32	0.3	0.3	0.4	0.5	0.6	ns			
		FO = 256	0.3	0.3	0.4	0.5	0.6	ns			
t _{SUEXT}	Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	ns			
		FO = 256	0.0	0.0	0.0	0.0	0.0	ns			
t _{HEXT}	Input Latch External Hold	FO = 32	2.3	2.6	3.0	3.5	4.9	ns			
		FO = 256	2.2	2.4	3.3	3.9	5.5	ns			
t _P	Minimum Period	FO = 32	3.4	3.7	4.0	4.7	7.8	ns			
		FO = 256	3.7	4.1	4.5	5.2	8.6	ns			
f _{MAX}	Maximum Frequency	FO = 32	296	269	247	215	129	MHz			
		FO = 256	268	244	224	195	117	MHz			

Table 39 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
TTL Output Module Timing⁵											
t _{DLH}	Data-to-Pad HIGH		3.4		3.8		4.3		5.1		7.1 ns
t _{DHL}	Data-to-Pad LOW		4.0		4.5		5.1		6.1		8.3 ns
t _{ENZH}	Enable Pad Z to HIGH		3.7		4.1		4.6		5.5		7.6 ns
t _{ENZL}	Enable Pad Z to LOW		4.1		4.5		5.1		6.1		8.5 ns
t _{ENHZ}	Enable Pad HIGH to Z		6.9		7.6		8.6		10.2		14.2 ns
t _{ENLZ}	Enable Pad LOW to Z		7.5		8.3		9.4		11.1		15.5 ns
t _{GLH}	G-to-Pad HIGH		5.8		6.5		7.3		8.6		12.0 ns
t _{GHL}	G-to-Pad LOW		5.8		6.5		7.3		8.6		12.0 ns
t _{LSU}	I/O Latch Set-Up	0.7		0.8		0.9		1.0		1.4	ns
t _{LH}	I/O Latch Hold	0.0		0.0		0.0		0.0		0.0	ns
t _{LCO}	I/O Latch Clock-to-Out (Pad-to-Pad), 64 Clock Loading		8.7		9.7		10.9		12.9		18.0 ns
t _{ACO}	Array Clock-to-Out (Pad-to-Pad), 64 Clock Loading		12.2		13.5		15.4		18.1		25.3 ns
d _{TLH}	Capacity Loading, LOW to HIGH	0.00		0.00		0.00		0.10		0.01	ns/pF
d _{THL}	Capacity Loading, HIGH to LOW	0.09		0.10		0.10		0.10		0.10	ns/pF

Table 40 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T_J = 70°C)

Parameter / Description		-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{PWL}	Minimum Pulse Width LOW	FO = 32	3.2	3.5	4.0	4.7	6.6	ns				
		FO = 384	3.7	4.1	4.6	5.4	7.6	ns				
t_{CKSW}	Maximum Skew	FO = 32		0.3	0.4	0.4	0.5	0.5	0.7	ns		
		FO = 384		0.3	0.4	0.4	0.5	0.5	0.7	ns		
t_{SUEXT}	Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	0.0	0.0	ns		
		FO = 384	0.0	0.0	0.0	0.0	0.0	0.0	0.0	ns		
t_{HEXT}	Input Latch External Hold	FO = 32	2.8	3.1	5.5	4.1	5.7	ns				
		FO = 384	3.2	3.5	4.0	4.7	6.6	ns				
t_P	Minimum Period	FO = 32	4.2	4.67	5.1	5.8	9.7	ns				
		FO = 384	4.6	5.1	5.6	6.4	10.7	ns				
f_{MAX}	Maximum Frequency	FO = 32		237	215	198	172	103	MHz			
		FO = 384		215	195	179	156	94	MHz			

Table 42 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, $V_{CCA} = 4.75$ V, $T_J = 70^\circ\text{C}$)

Parameter / Description		-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
Input Module Predicted Routing Delays²											
t_{IRD1}	FO = 1 Routing Delay		1.8		2.0		2.3		2.7		3.8 ns
t_{IRD2}	FO = 2 Routing Delay		2.1		2.3		2.6		3.1		4.3 ns
t_{IRD3}	FO = 3 Routing Delay		2.3		2.5		2.9		3.4		4.8 ns
t_{IRD4}	FO = 4 Routing Delay		2.5		2.8		3.2		3.7		5.2 ns
t_{IRD8}	FO = 8 Routing Delay		3.4		3.8		4.3		5.1		7.1 ns
Global Clock Network											
t_{CKH}	Input LOW to HIGH	FO = 32	2.6		2.9		3.3		3.9		5.4 ns
		FO = 486	2.9		3.2		3.6		4.3		5.9 ns
t_{CKL}	Input HIGH to LOW	FO = 32	3.7		4.1		4.6		5.4		7.6 ns
		FO = 486	4.3		4.7		5.4		6.3		8.8 ns
t_{PWH}	Minimum Pulse Width HIGH	FO = 32	2.2		2.4		2.7		3.2		4.5 ns
		FO = 486	2.4		2.6		3.0		3.5		4.9 ns
t_{PWL}	Minimum Pulse Width LOW	FO = 32	2.2		2.4		2.7		3.2		4.5 ns
		FO = 486	2.4		2.6		3.0		3.5		4.9 ns
t_{CKSW}	Maximum Skew	FO = 32	0.5		0.6		0.7		0.8		1.1 ns
		FO = 486	0.5		0.6		0.7		0.8		1.1 ns
t_{SUEXT}	Input Latch External Set-Up	FO = 32	0.0		0.0		0.0		0.0		ns
		FO = 486	0.0		0.0		0.0		0.0		ns
t_{HEXT}	Input Latch External Hold	FO = 32	2.8		3.1		3.5		4.1		5.7 ns
		FO = 486	3.3		3.7		4.2		4.9		6.9 ns
t_P	Minimum Period ($1/f_{MAX}$)	FO = 32	4.7		5.2		5.7		6.5		10.9 ns
		FO = 486	5.1		5.7		6.2		7.1		11.9 ns

Table 44 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)(Worst-Case Commercial Conditions, VCCA = 4.75 V, TJ = 70°C)

Parameter / Description		-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Asynchronous SRAM Operations												
t _{RPD}	Asynchronous Access Time		8.1		9.0		10.2		12.0		16.8	ns
t _{RDADV}	Read Address Valid		8.8		9.8		11.1		13.0		18.2	ns
t _{ADSU}	Address/Data Set-Up Time		1.6		1.8		2.0		2.4		3.4	ns
t _{ADH}	Address/Data Hold Time		0.0		0.0		0.0		0.0		0.0	ns
t _{RENSUA}	Read Enable Set-Up to Address Valid	0.6		0.7		0.8		0.9		1.3		ns
t _{RENHA}	Read Enable Hold		3.4		3.8		4.3		5.0		7.0	ns
t _{WENSU}	Write Enable Set-Up		2.7		3.0		3.4		4.0		5.6	ns
t _{WENH}	Write Enable Hold		0.0		0.0		0.0		0.0		0.0	ns
t _{DOH}	Data Out Hold Time		1.2		1.3		1.5		1.8		2.5	ns
Input Module Propagation Delays												
t _{INPY}	Input Data Pad-to-Y		1.0		1.1		1.3		1.5		2.1	ns
t _{INGO}	Input Latch Gate-to-Output		1.4		1.6		1.8		2.1		2.9	ns
t _{INH}	Input Latch Hold		0.0		0.0		0.0		0.0		0.0	ns
t _{INSU}	Input Latch Set-Up		0.5		0.5		0.6		0.7		1.0	ns
t _{ILA}	Latch Active Pulse Width		4.7		5.2		5.9		6.9		9.7	ns
Input Module Predicted Routing Delays²												
t _{IRD1}	FO = 1 Routing Delay		2.0		2.2		2.5		2.9		4.1	ns
t _{IRD2}	FO = 2 Routing Delay		2.3		2.6		2.9		3.4		4.8	ns
t _{IRD3}	FO = 3 Routing Delay		2.6		2.9		3.3		3.9		5.5	ns
t _{IRD4}	FO = 4 Routing Delay		3.0		3.3		3.8		4.4		6.2	ns
t _{IRD8}	FO = 8 Routing Delay		4.3		4.8		5.5		6.4		9.0	ns
Global Clock Network												
t _{CKH}	Input LOW to HIGH	FO = 32	2.7		3.0		3.4		4.0		5.6	ns
		FO = 635	3.0		3.3		3.8		4.4		6.2	ns
t _{CKL}	Input HIGH to LOW	FO = 32	3.8		4.2		4.8		5.6		7.8	ns
		FO = 635	4.9		5.4		6.1		7.2		10.1	ns
t _{PWH}	Minimum Pulse Width HIGH	FO = 32	1.8		2.0		2.2		2.6		3.6	ns
		FO = 635	2.0		2.2		2.5		2.9		4.1	ns
t _{PWL}	Minimum Pulse Width LOW	FO = 32	1.8		2.0		2.2		2.6		3.6	ns
		FO = 635	2.0		2.2		2.5		2.9		4.1	ns
t _{CKSW}	Maximum Skew	FO = 32	0.8		0.8		0.9		1.0		1.4	ns
		FO = 635	0.8		0.8		0.9		1.0		1.4	ns

Table 44 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)(Worst-Case Commercial Conditions, VCCA = 4.75 V, TJ = 70°C)

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
TTL Output Module Timing⁵ (Continued)											
t _{ENLZ}	Enable Pad LOW to Z	4.9	5.5	6.2	7.3	10.2	ns				
t _{GLH}	G-to-Pad HIGH	2.9	3.3	3.7	4.4	6.1	ns				
t _{GHL}	G-to-Pad LOW	2.9	3.3	3.7	4.4	6.1	ns				
t _{LSU}	I/O Latch Output Set-Up	0.5	0.5	0.6	0.7	1.0	ns				
t _{LH}	I/O Latch Output Hold	0.0	0.0	0.0	0.0	0.0	ns				
t _{LCO}	I/O Latch Clock-to-Out (Pad-to-Pad) 32 I/O	5.7	6.3	7.1	8.4	11.8	ns				
t _{ACO}	Array Latch Clock-to-Out (Pad-to-Pad) 32 I/O	7.8	8.6	9.8	11.5	16.1	ns				
d _{TLH}	Capacitive Loading, LOW to HIGH	0.07	0.08	0.09	0.10	0.14	ns/pF				
d _{THL}	Capacitive Loading, HIGH to LOW	0.07	0.08	0.09	0.10	0.14	ns/pF				

Table 50 • PQ 100

PQ100	Pin Number	A40MX02 Function	A40MX04 Function	A42MX09 Function	A42MX16 Function
56	VCC	VCC	I/O	I/O	
57	I/O	I/O	GND	GND	
58	I/O	I/O	I/O	I/O	
59	I/O	I/O	I/O	I/O	
60	I/O	I/O	I/O	I/O	
61	I/O	I/O	I/O	I/O	
62	I/O	I/O	I/O	I/O	
63	GND	GND	I/O	I/O	
64	I/O	I/O	LP	LP	
65	I/O	I/O	VCCA	VCCA	
66	I/O	I/O	VCCI	VCCI	
67	I/O	I/O	VCCA	VCCA	
68	I/O	I/O	I/O	I/O	
69	VCC	VCC	I/O	I/O	
70	I/O	I/O	I/O	I/O	
71	I/O	I/O	I/O	I/O	
72	I/O	I/O	GND	GND	
73	I/O	I/O	I/O	I/O	
74	I/O	I/O	I/O	I/O	
75	I/O	I/O	I/O	I/O	
76	I/O	I/O	I/O	I/O	
77	NC	NC	I/O	I/O	
78	NC	NC	I/O	I/O	
79	NC	NC	SDI, I/O	SDI, I/O	
80	NC	I/O	I/O	I/O	
81	NC	I/O	I/O	I/O	
82	NC	I/O	I/O	I/O	
83	I/O	I/O	I/O	I/O	
84	I/O	I/O	GND	GND	
85	I/O	I/O	I/O	I/O	
86	GND	GND	I/O	I/O	
87	GND	GND	PRA, I/O	PRA, I/O	
88	I/O	I/O	I/O	I/O	
89	I/O	I/O	CLKA, I/O	CLKA, I/O	
90	CLK, I/O	CLK, I/O	VCCA	VCCA	
91	I/O	I/O	I/O	I/O	
92	MODE	MODE	CLKB, I/O	CLKB, I/O	

Table 52 • PQ160

PQ160	Pin Number	A42MX09 Function	A42MX16 Function	A42MX24 Function
	21	CLKA, I/O	CLKA, I/O	CLKA, I/O
	22	I/O	I/O	I/O
	23	PRA, I/O	PRA, I/O	PRA, I/O
	24	NC	I/O	WD, I/O
	25	I/O	I/O	WD, I/O
	26	I/O	I/O	I/O
	27	I/O	I/O	I/O
	28	NC	I/O	I/O
	29	I/O	I/O	WD, I/O
	30	GND	GND	GND
	31	NC	I/O	WD, I/O
	32	I/O	I/O	I/O
	33	I/O	I/O	I/O
	34	I/O	I/O	I/O
	35	NC	VCCI	VCCI
	36	I/O	I/O	WD, I/O
	37	I/O	I/O	WD, I/O
	38	SDI, I/O	SDI, I/O	SDI, I/O
	39	I/O	I/O	I/O
	40	GND	GND	GND
	41	I/O	I/O	I/O
	42	I/O	I/O	I/O
	43	I/O	I/O	I/O
	44	GND	GND	GND
	45	I/O	I/O	I/O
	46	I/O	I/O	I/O
	47	I/O	I/O	I/O
	48	I/O	I/O	I/O
	49	GND	GND	GND
	50	I/O	I/O	I/O
	51	I/O	I/O	I/O
	52	NC	I/O	I/O
	53	I/O	I/O	I/O
	54	NC	VCCA	VCCA
	55	I/O	I/O	I/O
	56	I/O	I/O	I/O
	57	VCCA	VCCA	VCCA

Table 52 • PQ160

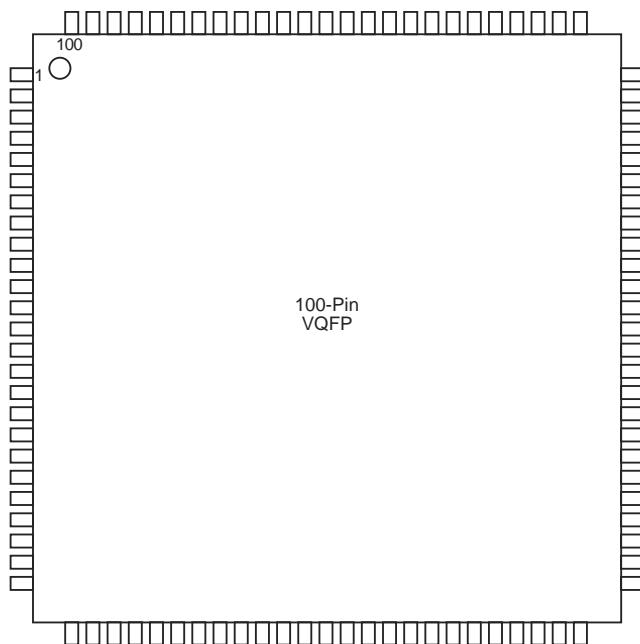
PQ160	Pin Number	A42MX09 Function	A42MX16 Function	A42MX24 Function
	58	VCCI	VCCI	VCCI
	59	GND	GND	GND
	60	VCCA	VCCA	VCCA
	61	LP	LP	LP
	62	I/O	I/O	TCK, I/O
	63	I/O	I/O	I/O
	64	GND	GND	GND
	65	I/O	I/O	I/O
	66	I/O	I/O	I/O
	67	I/O	I/O	I/O
	68	I/O	I/O	I/O
	69	GND	GND	GND
	70	NC	I/O	I/O
	71	I/O	I/O	I/O
	72	I/O	I/O	I/O
	73	I/O	I/O	I/O
	74	I/O	I/O	I/O
	75	NC	I/O	I/O
	76	I/O	I/O	I/O
	77	NC	I/O	I/O
	78	I/O	I/O	I/O
	79	NC	I/O	I/O
	80	GND	GND	GND
	81	I/O	I/O	I/O
	82	SDO, I/O	SDO, I/O	SDO, TDO, I/O
	83	I/O	I/O	WD, I/O
	84	I/O	I/O	WD, I/O
	85	I/O	I/O	I/O
	86	NC	VCCI	VCCI
	87	I/O	I/O	I/O
	88	I/O	I/O	WD, I/O
	89	GND	GND	GND
	90	NC	I/O	I/O
	91	I/O	I/O	I/O
	92	I/O	I/O	I/O
	93	I/O	I/O	I/O
	94	I/O	I/O	I/O

Table 53 • PQ208

PQ208	Pin Number	A42MX16 Function	A42MX24 Function	A42MX36 Function
	132	VCCI	VCCI	VCCI
	133	VCCA	VCCA	VCCA
	134	I/O	I/O	I/O
	135	I/O	I/O	I/O
	136	VCCA	VCCA	VCCA
	137	I/O	I/O	I/O
	138	I/O	I/O	I/O
	139	I/O	I/O	I/O
	140	I/O	I/O	I/O
	141	NC	I/O	I/O
	142	I/O	I/O	I/O
	143	I/O	I/O	I/O
	144	I/O	I/O	I/O
	145	I/O	I/O	I/O
	146	NC	I/O	I/O
	147	NC	I/O	I/O
	148	NC	I/O	I/O
	149	NC	I/O	I/O
	150	GND	GND	GND
	151	I/O	I/O	I/O
	152	I/O	I/O	I/O
	153	I/O	I/O	I/O
	154	I/O	I/O	I/O
	155	I/O	I/O	I/O
	156	I/O	I/O	I/O
	157	GND	GND	GND
	158	I/O	I/O	I/O
	159	SDI, I/O	SDI, I/O	SDI, I/O
	160	I/O	I/O	I/O
	161	I/O	WD, I/O	WD, I/O
	162	I/O	WD, I/O	WD, I/O
	163	I/O	I/O	I/O
	164	VCCI	VCCI	VCCI
	165	NC	I/O	I/O
	166	NC	I/O	I/O
	167	I/O	I/O	I/O
	168	I/O	WD, I/O	WD, I/O

Table 54 • PQ240

PQ240	
Pin Number	A42MX36 Function
200	I/O
201	I/O
202	I/O
203	I/O
204	I/O
205	I/O
206	VCCA
207	I/O
208	I/O
209	VCCA
210	VCCI
211	I/O
212	I/O
213	I/O
214	I/O
215	I/O
216	I/O
217	I/O
218	I/O
219	VCCA
220	I/O
221	I/O
222	I/O
223	I/O
224	I/O
225	I/O
226	I/O
227	VCCI
228	I/O
229	I/O
230	I/O
231	I/O
232	I/O
233	I/O
234	I/O
235	I/O
236	I/O

Figure 47 • VQ100**Table 56 • VQ100**

VQ100		
Pin Number	A42MX09 Function	A42MX16 Function
1	I/O	I/O
2	MODE	MODE
3	I/O	I/O
4	I/O	I/O
5	I/O	I/O
6	I/O	I/O
7	GND	GND
8	I/O	I/O
9	I/O	I/O
10	I/O	I/O
11	I/O	I/O
12	I/O	I/O
13	I/O	I/O
14	VCCA	NC
15	VCCI	VCCI
16	I/O	I/O
17	I/O	I/O
18	I/O	I/O
19	I/O	I/O
20	GND	GND

Table 59 • CQ256

CQ256	
Pin Number	A42MX36 Function
133	I/O
134	I/O
135	I/O
136	I/O
137	I/O
138	I/O
139	GND
140	I/O
141	I/O
142	I/O
143	I/O
144	I/O
145	I/O
146	I/O
147	I/O
148	I/O
149	I/O
150	I/O
151	I/O
152	I/O
153	I/O
154	I/O
155	VCCA
156	I/O
157	I/O
158	VCCA
159	VCCI
160	GND
161	I/O
162	I/O
163	I/O
164	I/O
165	GND
166	I/O
167	I/O
168	I/O
169	I/O

Table 60 • BG272

BG272	
Pin Number	A42MX36 Function
M10	GND
M11	GND
M12	GND
M17	I/O
M18	I/O
M19	I/O
M20	I/O
N1	I/O
N2	I/O
N3	I/O
N4	VCCI
N17	VCCI
N18	I/O
N19	I/O
N20	I/O
P1	I/O
P2	I/O
P3	I/O
P4	VCCA
P17	I/O
P18	I/O
P19	I/O
P20	I/O
R1	I/O
R2	I/O
R3	I/O
R4	VCCI
R17	VCCI
R18	I/O
R19	I/O
R20	I/O
T1	I/O
T2	I/O
T3	I/O
T4	I/O
T17	VCCA
T18	I/O

Figure 53 • CQ172**Table 62 • CQ172**

CQ172	
Pin Number	A42MX16 Function
1	MODE
2	I/O
3	I/O
4	I/O
5	I/O
6	I/O
7	GND
8	I/O
9	I/O
10	I/O
11	I/O
12	VCC
13	I/O
14	I/O
15	I/O
16	I/O
17	GND
18	I/O
19	I/O
20	I/O